



Docket No.: AB-937 US

March 23, 2000



Box Patent Application Assistant Commissioner for Patents Washington, D. C. 20231 Enclosed herewith for filing is a patent application, as follows: Cho, Tae Je; Lee, Kwan Jai; Lyu, Ju Hyun Inventor(s): Thin Stacked Package And Manufacturing Method Thereof Title: Return Receipt Postcard This Transmittal Letter (in duplicate) page(s) Specification (not including claims) page(s) Claims page Abstract Sheet(s) of Drawings page(s) Declaration For Patent Application and Power of Attorney page(s) Recordation Form Cover Sheet (in duplicate) page(s) Assignment page(s) PTO Form 1449 citing 5 references Copy(ies) of 5 Cited References submitted Other: Certified copy of Korean Application

CLAIMS AS FILED

			CLA.	INIO AO I ID					
For Total Claims	Number Filed 28	-20	=	Number Extra 8	x	Rate \$18.00	==	\$ \$	Basic Fee \$690.00 144.00
Independent	3	-3	=	0	х	\$78.00		\$	0.00
Claims Fee of for the first filing of one or more multiple dependent claims per application								\$	
Fee for Request for Extension of Time								\$	

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Respectfully submitted, and his Heid

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